Electronic Acknowledgement Receipt					
EFS ID:	1306776				
Application Number:	09712749				
International Application Number:					
Confirmation Number:	9765				
Title of Invention:	Low profile integrated module interconnects and method of fabrication				
First Named Inventor/Applicant Name:	Chia-Yu Fu				
Customer Number:	23125				
Filer:	David George Dolezal/Dora Hudgins				
Filer Authorized By:	David George Dolezal				
Attorney Docket Number:	CT00-020				
Receipt Date:	10-NOV-2006				
Filing Date:	14-NOV-2000				
Time Stamp:	16:45:32				
Application Type:	Utility				

Payment information:

Submitted with Payment	no	
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part /.zip	Pages (if appl.)
1	Request for status of Application	CT00-020-US-2006-11-10-St atusReport.pdf	125232	no	1
Warnings:					

Information:					
Total Files Size (in bytes):	125232				

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.